

Si PIN photodiode

S14016-01DT

Compact photosensor in a plastic package

The S14016-01DT is a Si PIN photodiode for visible to near infrared range. It is provided in a compact surface mount type plastic package.

Features

Applications

■ Surface mount type, compact

Optical switches

- Package size: 4 × 3 mm
- **Photosensitive area: 1.8 × 2.1 mm**
- ⇒ High sensitivity: 0.7 A/W (λ=960 nm)

- Structure

Parameter	Specification	Unit
Photosensitive area	2.1 × 1.8	mm
Package	Ероху	-

→ Absolute maximum ratings

Parameter	Symbol	Condition	Value	Unit
Reverse voltage	VR max	Ta=25 °C	10	٧
Operating temperature	Topr	No dew condensation*1	-40 to +85	°C
Storage temperature	Tstg	No dew condensation*1	-40 to +100	°C
Soldering temperature*2	Tsol		240 (twice)	°C

^{*1:} When there is a temperature difference between a product and the surrounding area in high humidity environment, dew condensation may occur on the product surface. Dew condensation on the product may cause deterioration in characteristics and reliability.

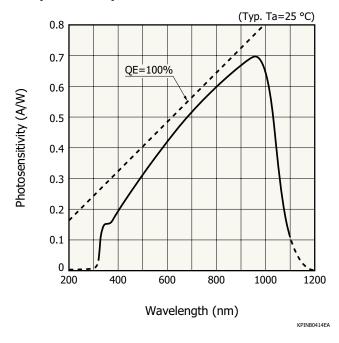
■ Electrical and optical characteristics (Ta=25 °C)

Parameter	Symbol	Condition	Min.	Тур.	Max.	Unit
Spectral response range	λ		-	320 to 1100	-	nm
Peak sensitivity wavelength	λр		-	960	-	nm
Photosensitivity	S	$\lambda = \lambda p$	0.6	0.7	-	A/W
Dark current	ID	VR=5 V	-	0.1	10	nA
Temperature coefficient of dark current	TCID	VR=5 V	-	1.15	-	times/°C
Cutoff frequency	fc	VR=5 V, RL=50 Ω -3 dB	5	10	-	MHz
Terminal capacitance	Ct	VR=5 V, f=1 MHz	-	12	24	pF

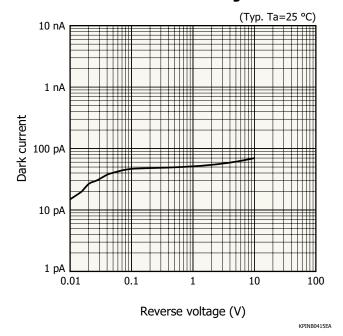
^{*2:} Reflow soldering, JEDEC J-STD-020 MSL 4, see P.5

Note: Exceeding the absolute maximum ratings even momentarily may cause a drop in product quality. Always be sure to use the product within the absolute maximum ratings.

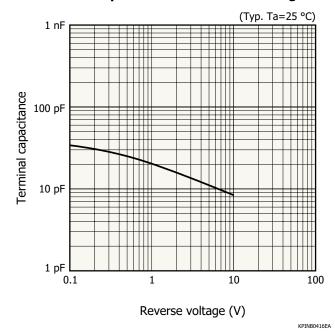
Spectral response



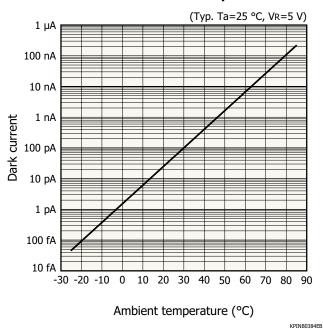
Dark current vs. reverse voltage



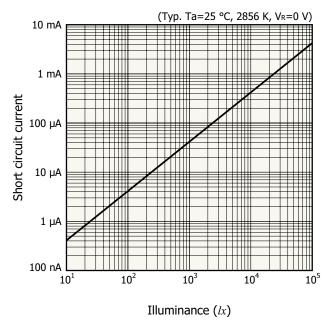
Terminal capacitance vs. reverse voltage



Dark current vs. ambient temperature

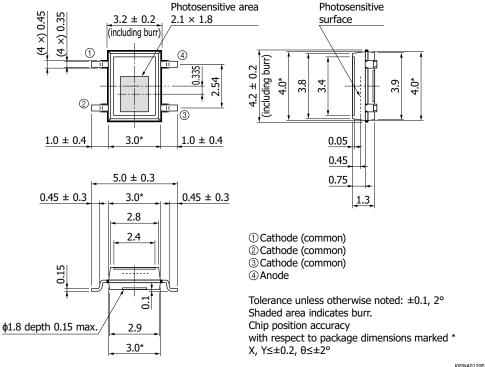


Short circuit current vs. illuminance



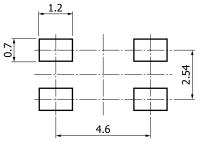
KPINB0419EA

Dimensional outline (unit: mm)



KPINA0120EA

Recommended land pattern (unit: mm)



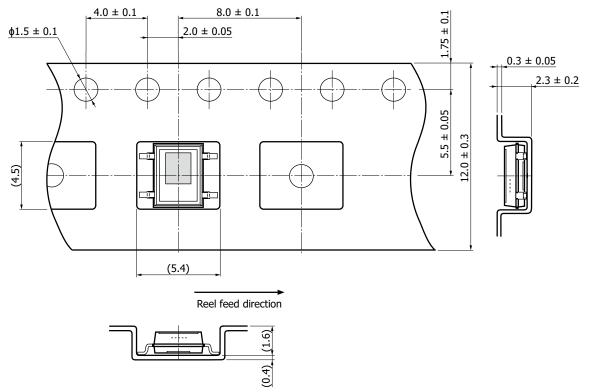
KPINC0029EA

Standard packing specifications

■ Reel (conforms to JEITA ET-7200)

Reel outer diameter	Hub diameter	Tape width	Material	Electrostatic characteristics
254 mm	80 mm	12 mm	PS	Conductive

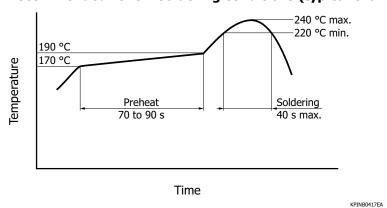
■ Embossed tape (unit: mm)



KPINC0030EA

- Packing quantity 2000 pcs/reel
- Packing type
 Reel and desiccant in moisture-proof packaging (vacuum-sealed)

Recommended reflow soldering conditions (typical example)



- · After unpacking, keep it in an environment at 5 to 30 °C and a humidity of 60% or less. Perform reflow soldering within 72 hours.
- · The effect that the product receives during reflow soldering varies depending on the circuit board and reflow oven that are used. When you set reflow soldering conditions, check that problems do not occur in the product by testing out the conditions in advance. Drastic changes in temperature can cause problems. Set the temperature change to less than 4 °C/second.

The content of this document is current as of March 2020.

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